



### Project

HaloFreeEtch aims to revolutionize semiconductor manufacturing by developing an environmentally sustainable etching process that eliminates the use of halogenated compounds.

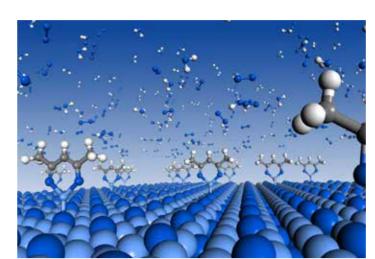
Funded by the European Union, this innovative initiative brings together leading experts from academia, research institutions, and industry to address the critical need for greener manufacturing technologies. Byleveraging cutting-edge plasma etching techniques and advanced materials science, HaloFreeEtch strives to reduce the environmental footprint of semiconductor production while maintaining high performance and cost-effectiveness.

### Case Studies



Development of a deep etching process for aapacitive sensors without halogens

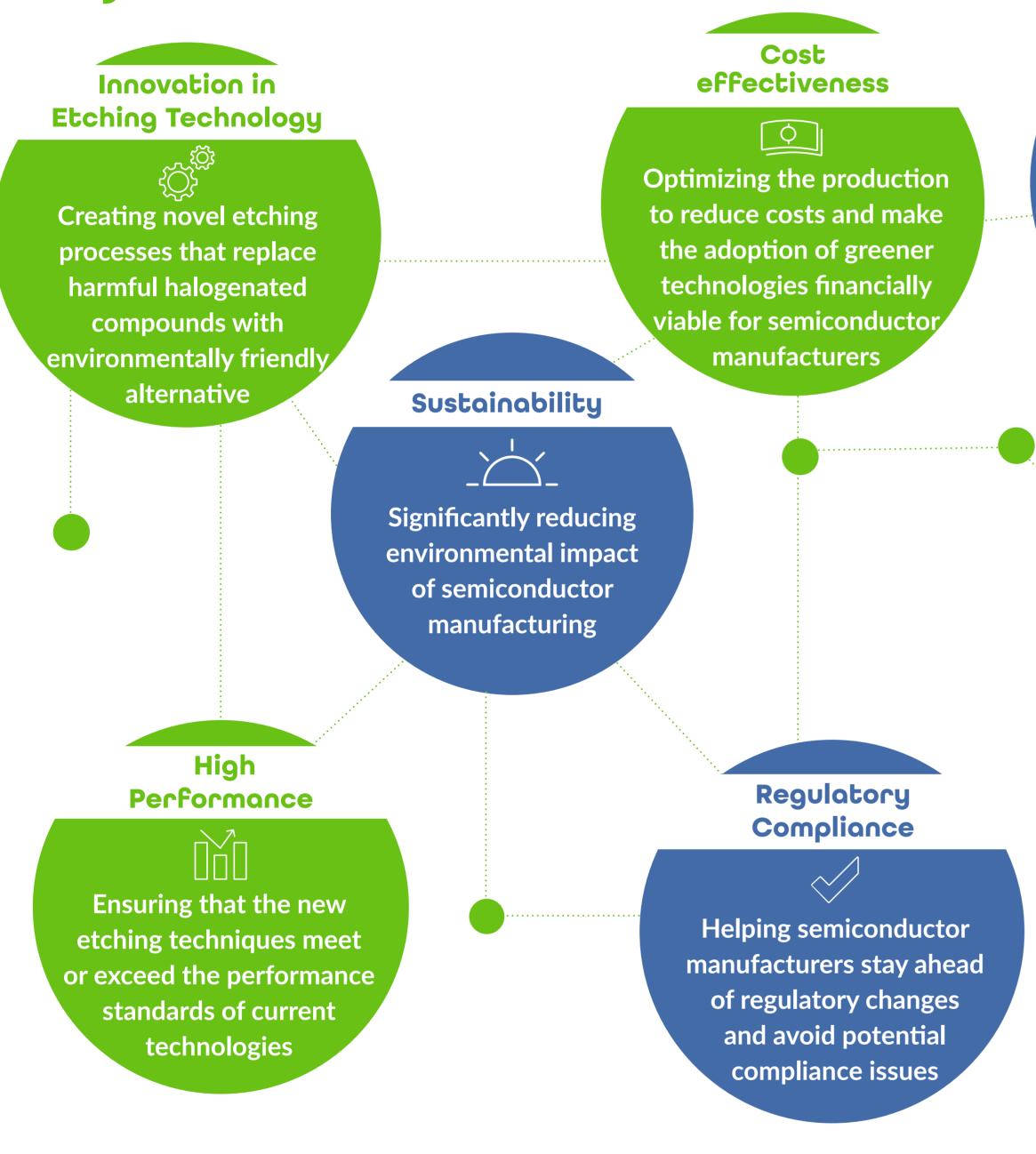
Reduce environmental impact and improve process efficiency.



# Multi-Scale modeling for etching process optimization

Development of multi-scale models to predict and optimize energy efficiency and etching speed.

## Objectives



#### Knowledge Transfer

Fostering collaboration between leading academic institutions, research organizations, and industry partners

Educational Outreach

Developing educational materials, organizing workshops, and creating opportunities for hands-on learning experiences

#### Market Readiness

Ensuring that the halogenfree etching processes are ready for large-scale adoption and can be seamlessly integrated into existing production lines

## Expected Impacts

HaloFreeEtch aims to significantly impact both the **semiconductor industry** and the environment by eliminating the use of harmful halogenated compounds in etching processes. This reduction in ecological footprint aligns with global efforts to combat **climate change** and promote **sustainable practices**.

The project will enhance the European semiconductor industry's competitiveness by developing cutting-edge, environmentally compliant technologies, essential as the EU enforces stricter regulations on **fluorochemicals**. This innovation will lower costs and improve compliance with environmental standards.

#### Partners











tinexta innovation hub



### Project details

Project number: 101161153

Project name: Novel approaches for halogen-free and sustainable

etching of Silicon and Glass **Project acronym:** HaloFreeEtch

**Topic:** HORIZON-EIC-2023-PATHFINDERCHALLENGES-01-04

Type of action: HORIZON-EIC

Project starting date: 1 September 2024

**Project duration: 48** 

**EU Contribution:** 3.997.735,00 Euro

### Contacts

#### PROJECT COORDINATOR

Jörg Schuster | Chemnitz University of Technology joerg.schuster@zfm.tu-chemnitz.de

#### DISSEMINATION MANAGER

Isella Vicini | Tinexta Innovation Hub isella.vicini@tinextainnovationhub.com



"Funded by the European Union. Views and opinions expressed are however those of the author(s) only and do not necessarily reflect those of European Innovation Council and SMEs Executive Agency (EISMEA). Neither the European Union nor the granting authority can be held responsible for them."

HALOFREEETCH has received funding from the European Union under grant agreement n° 101161153